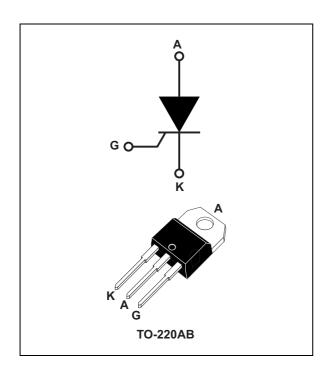


TYN640, TYN840

40 A standard SCRs

Datasheet - production data



Description

These standard SCRs are suitable for applications where in-rush current conditions are critical, such as overvoltage crowbar protection circuits in power supplies, in-rush current limiting circuits, solid state relays (in back to back configuration), welding equipment, high power motor control circuits.

Using clip assembly technology, they provide a superior performance in high surge current capabilities.

Table 1. Device summary

Order code	Voltage	Sensitivity
TYN640RG	600 V	35 mA
TYN840RG	800 V	35 mA

Features

- On-state rms current, I_{T(RMS):} 40 A
- Repetitive peak off-stat voltage, V_{DRM}, V_{RRM}:
 - 600 V
 - 800 V
- Triggering gate current, I_{GT}: 35 mA

Characteristics TYN640, TYN840

1 Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Parameter			Value	Unit	
I _{T(RMS)}	On-state rms current (180° conduction	angle)	T _c = 95 °C	40	Α	
IT _(AV)	Average on-state current (180° conduc	ction angle)	T _c = 95 °C	25	Α	
	Non repetitive surge peak on-state current	$t_p = 8.3 \text{ ms}$	T = 25 °C	480	А	
I _{TSM}		t _p = 10 ms	$T_j = 25 ^{\circ}C$	460		
l ² t	I^2 t Value for fusing $t_p = 10 \text{ ms}$		T _j = 25 °C	1060	A ² s	
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \le 100 \text{ ns}$	F = 60 Hz	T _j = 125 °C	50	A/µs	
I _{GM}	Peak gate current $t_p = 20 \mu s$		T _j = 125 °C	4	А	
P _{G(AV)}	Average gate power dissipation $T_j = {}^{\circ}C$		T _j = 125 °C	1	W	
T _{stg} T _j	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 125	°C	
V _{RGM}	Maximum peak reverse gate voltage			5	V	

Table 3. Electrical Characteristics ($T_j = 25$ °C, unless otherwise specified)

Symbol	Test Conditions			Value	Unit
			MIN.	3.5	A
I _{GT}	$V_D = 12 \text{ V}$ $R_L = 33 \Omega$	·	MAX.	35	mA
V _{GT}			MAX.	1.3	V
V _{GD}	$V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$	T _j = 125 °C	MIN.	0.2	V
I _H	I _T = 500 mA Gate open		MAX.	75	mA
ΙL	$I_G = 1.2 \times I_{GT}$		MAX.	150	mA
dV/dt	V _D = 67% V _{DRM} Gate open	T _j = 125 °C	MIN.	1000	V/µs
V_{TM}	$I_{TM} = 80 \text{ A}$ $t_p = 380 \mu\text{s}$	T _j = 25 °C	MAX.	1.6	V
V _{t0}	Threshold voltage	T _j = 125 °C	MAX.	0.85	V
R _d	Dynamic resistance	T _j = 125 °C	MAX.	10	mΩ
I _{DRM}	$T_j =$		MAX.	5	μA
I _{RRM}	$V_{DRM} = V_{RRM}$	T _j = 125 °C	IVIAA.	4	mA

Table 4. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case (DC)	0.8	°C/W
R _{th(j-a)}	Junction to ambient (DC)	60	°C/W



TYN640, TYN840 Characteristics

Figure 1. Maximum average power dissipation versus average on-state current P(W) 40 35 30 25 20 15 10 I_{T(AV)}(A) α 15 5 10 20 25 30

Figure 3. Relative variation of thermal impedance versus pulse duration

K=[Z_{th}/R_{th}]

0.10

t_p(s)

1E-3

1E-2

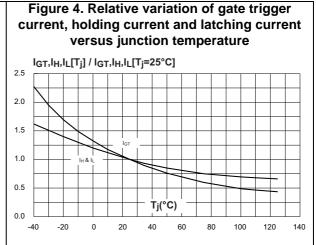
1E-1

1E+0

1E+1

1E+2

5E+2



Characteristics TYN640, TYN840

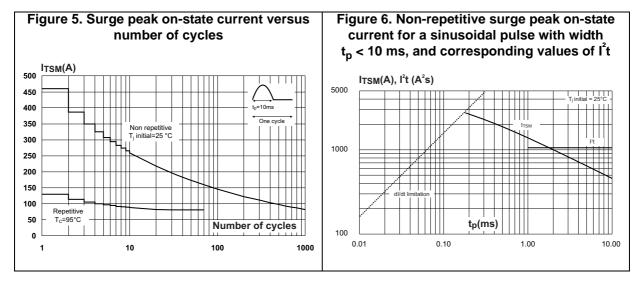
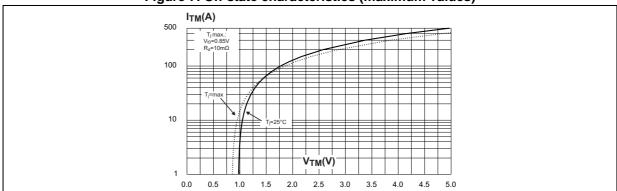


Figure 7. On-state characteristics (maximum values)



TYN640, TYN840 Package information

2 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

В ØΙ b2 F Α 14 13 c2 **a**1 12 **a2** b1

Figure 8. TO-220AB dimension definitions

Package information TYN640, TYN840

Table 5. TO-220AB dimension values

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	Dimensions					
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
В	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
С	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
е	2.40		2.70	0.094		0.106
F	6.20		6.60	0.244		0.259
ØI	3.75		3.85	0.147		0.151
14	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
12	1.14		1.70	0.044		0.066
13	1.14		1.70	0.044		0.066
М		2.60			0.102	

TYN640, TYN840 Ordering information

3 Ordering information

Figure 9. Ordering Information Scheme

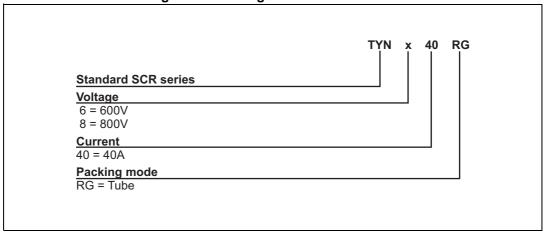


Table 6. Ordering Information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
TYN640RG	TYN640	TO-220AB	2.3 g	50	Tube
TYN840RG	TYN840	10-220AD	2.5 g	30	Tube

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
Apr-2002	4A	Last update.
13-Feb-2006	5	TO-220AB delivery mode changed from bulk to tube. ECOPACK statement added.
05-Nov-2013	6	Updated Figure 5.

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